imall

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2A, 100V - 200V Surface Mount Ultra Fast Rectifiers

FEATURES

- Low power loss, high efficiency
- Ideal for automated placement
- Ultra fast recovery time for high efficiency
- High surge current capability
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

MECHANICAL DATA

Case: DO-214AC (SMA)

Molding compound, UL flammability classification rating 94V-0 Moisture sensitivity level: level 1, per J-STD-020 Part No. with suffix "H" means AEC-Q101 qualified Packing code with suffix "G" means green compound (halogen-free) **Terminal:** Matte tin plated leads, solderable per JESD22-B102 Meet JESD 201 class 2 whisker test **Polarity:** Indicated by cathode band **Weight:** 0.07 g (approximately)







DO-214AC (SMA)

PARAMETER	SYMBOL	ESH2BA	ESH2CA	ESH2DA	Unit
Maximum repetitive peak reverse voltage	V _{RRM}	100	150	200	V
Maximum RMS voltage	V _{RMS}	70	105	140	V
Maximum DC blocking voltage	V _{DC}	100	150	200	V
Maximum average forward rectified current	I _{F(AV)}	1		А	
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	50		А	
Maximum instantaneous forward voltage (Note 1) @ 1 A	V _F	0.90		V	
T _J =25°C			1		
Maximum reverse current @ rated V _R T _J =100°C	I _R	10 50		μA	
T _J =125°C					
Maximum reverse recovery time (Note 2)	t _{rr}	25		ns	
Pulse energy in avalanche mode, non repetitive (inductive load switch off), L=120mH	E _{RSM}	20		mJ	
Typical junction capacitance (Note 3)	CJ	25		pF	
Typical thermal resistance	R _{θJL} R _{θJA}	20 75		°C/W	
Operating junction temperature range	TJ	- 55 to +175		°C	
Storage temperature range	T _{STG}	- 55 to +175		°C	

Note 1: Pulse test with PW=300µs, 1% duty cycle

Note 2: Reverse Recovery Test Conditions: I_F =0.5A, I_R =1.0A, I_{RR} =0.25A

Note 3: Measured at 1 MHz and Applied Reverse Voltage of 4.0V D.C.



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ORDERING INFORMATION					
PART NO.	PART NO.	PACKING CODE	PACKING CODE	PACKAGE	PACKING
	SUFFIX		SUFFIX (*)		
		R3		SMA	1,800 / 7" Plastic reel
ESH2xA H (Note 1)		R2		SMA	7,500 / 13" Paper reel
	M2	G	SMA	7,500 / 13" Plastic reel	
	11	F3	9	Folded SMA	1,800 / 7" Plastic reel
		F2		Folded SMA	7,500 / 13" Paper reel
		F4		Folded SMA	7,500 / 13" Plastic reel

Note 1: "xx" defines voltage from 100V (ESH2BA) to 200V (ESH2DA)

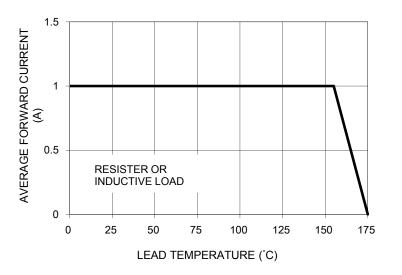
*: Optional available

EXAMPLE					
PREFERRED P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
ESH2DAHR3G	ESH2DA	Н	R3	G	AEC-Q101 qualified Green compound

RATINGS AND CHARACTERISTICS CURVES

(T_A=25°C unless otherwise noted)





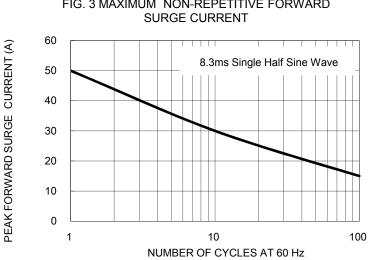
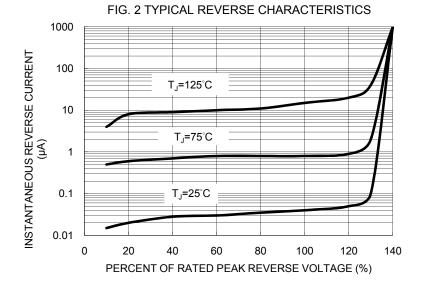
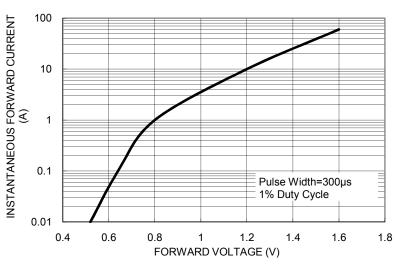


FIG. 3 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT









60

50

40

30

20

10

0 0.1

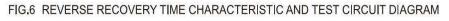
CAPACITANCE (pF)

Taiwan Semiconductor

FIG. 5 TYPICAL JUNCTION CAPACITANCE

10

REVERSE VOLTAGE (V)



50Ω NONINDUCTIVE 10Ω NONINDUCTIVE

Unit (mm)

Min

1.27

4.06

Max

1.58

4.60

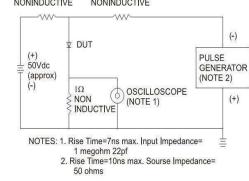
2.83

2.50

1.41 5.33

0.20

0.31



Unit (inch)

Max

0.062

0.181

0.111

0.098

0.056

0.210

0.008

0.012

Min

0.050

0.160

0.090

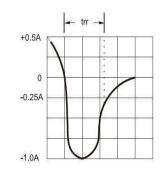
0.078

0.035

0.195

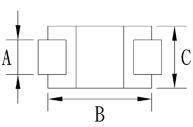
0.004

0.006



PACKAGE OUTLINE DIMENSIONS DO-214AC (SMA)

1



	С	2.29
	D	1.99
	E	0.90
	F	4.95
Н	G	0.10
	Н	0.15

100

DIM.

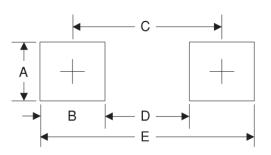
А

В

SUGGESTED PAD LAYOUT

E

D



G

F

Symbol	Unit (mm)	Unit (inch)
A	1.68	0.066
В	1.52	0.060
С	3.93	0.155
D	2.41	0.095
E	5.45	0.215

MARKING DIAGRAM



P/N =Specific Device Code

Green Compound G =

- YW = Date Code
- F = Factory Code



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